Electronic Patent Application Fee Transmittal							
Application Number:	10	10660054					
Filing Date:	11-Sep-2003						
Title of Invention:	Method of manufacturing clad board for forming circuitry, clad board and core board for clad board						
First Named Inventor/Applicant Name:	Shigeru Yamane						
Filer:	Lawrence E. Ashery						
Attorney Docket Number:	MAT-8260US1						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Tota	810		